

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: Sailesh Chittipeddi, et al.

Serial No.: 09/467,253

Filed: December 20, 1999

For: WIRE BONDING METHOD FOR COPPER INTERCONNECTS
IN SEMICONDUCTOR DEVICES

Group No.: 2823

Examiner: Estrada, Michelle

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of Hitt Gaines & Boisbrun, P.C.; P.O. Box 832570, Richardson, Texas 75083 as our associate attorneys in the above-mentioned application, with full power to prosecute said application, to make alterations and amendments therein, and to transact all business in the Patent and Trademark Office connected therewith.

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